### TIC216 SERIES SILICON TRIACS

- Sensitive Gate Triacs
- 6 A RMS
- Glass Passivated Wafer
- 400 V to 800 V Off-Staate Voltage
- Max Igt of 5 mA (Quadrants 1 3)



Pin 2 is In electrical contaci with the mounting base.

MDC2ACA

### absolute maximum ratings over operating case temperature (unless otherwise noted)

RATING	TIC216D	SYMBOL	VALUE400	UNIT
Repetitive peak off-state voltage (see Note 1)	TIC216M TIC216S	V <sub>DRM</sub>	600 700	v
	TIC216N		800	
Full-cycle RMS on-state current at (or below) 70°C case temperature (see Note 2)			6	A
Peak on-state surge current full-sine-wave (see Note 3)			60	A
Peak on-state surge current half-sine-wave (see Note 4)			70	A
Peak gate current			±1	A
Peak gate power dissipation at (or below) 85°C case temperature (pulse width ≤ 200 µs)			2.2	w
Average gate power dissipation at (or below) 85°C case temperature (see Note 5)			0.9	Ŵ
Operating case temperature range		тс	-40 to +110	°C
Storage temperature range			-40 to +125	°C
Lead temperature 1.6 mm from case for 10 seconds			230	°C

NOTES: 1. These values apply bidirectionally for any value of resistance between the gate and Main Terminal 1.

 This value applies for 50-Hz full-sine-wave operation with resistive load. Above 70°C derate linearly to 110°C case temperature at the rate of 150 mA\*C.

3. This value applies for one 50-Hz full-sine-wave when the device is operating at (or below) the rated value of on-state current. Surge may be repeated after the device has returned to original thermal equilibrium. During the surge, gate control may be lost.

4. This value applies for one 50-Hz half-sine-wave when the device is operating at (or below) the rated value of on-state current. Surge may be repeated after the device has returned to original thermal equilibrium. During the surge, gate control may be tost.

5. This value applies for a maximum averaging time of 20 ms.

#### electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS			· MIN	ТҮР	MAX	UNIT
1 <sub>DRM</sub>	Repetitive peak off-state current	V <sub>D</sub> = rated V <sub>DRM</sub>	l <sub>G</sub> = 0	T <sub>C</sub> = 110°C			±2	mA
<sup>I</sup> Gтм	Peak gate trigger current	V <sub>supply</sub> = +12 V† V <sub>supply</sub> = +12 V† V <sub>supply</sub> = -12 V† V <sub>supply</sub> = -12 V†	$R_{L} = 10 \Omega$ $R_{L} = 10 \Omega$ $R_{L} = 10 \Omega$ $R_{L} = 10 \Omega$	t <sub>p(g)</sub> > 20 μs t <sub>p(g)</sub> > 20 μs t <sub>p(g)</sub> > 20 μs t <sub>p(g)</sub> > 20 μs			5 -5 -5 10	mA
V <sub>GTM</sub>	Peak gate trigger voltage	$V_{supply} = +12 V^{\dagger}$ $V_{supply} = +12 V^{\dagger}$ $V_{supply} = -12 V^{\dagger}$ $V_{supply} = -12 V^{\dagger}$	$R_{L} = 10 \Omega$	t <sub>p(g)</sub> > 20 μs t <sub>p(g)</sub> > 20 μs t <sub>p(g)</sub> > 20 μs t <sub>p(g)</sub> > 20 μs t <sub>p(g)</sub> > 20 μs			2.2 -2.2 -2.2 3	v

† All voltages are with respect to Main Terminal 1.

# PRODUCT INFORMATION

Information is current as of publication date. Products conform to specifications in accordance with the terms of Power Innovations Standard warranty. Production processing does not necessarily indude testing of all Parameters.



1000

### **TIC216 SERIES** SILICON TRIACS

### DECEMBER 1971- REVISED MARCH 1997

### electrical characteristics at 25°C case temperature (unless otherwise noted) (continued)

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
VTM	Peak on-state voltage	I <sub>TM</sub> = ±8.4 A	I <sub>G</sub> = 50 mA	(see Note 6)			±1.7	v
Iн	Holding current	$V_{supply} = +12 V^{\dagger}$ $V_{supply} = -12 V^{\dagger}$	$I_G = 0$ $I_G = 0$	Init' I <sub>TM</sub> = 100 mA Init' I <sub>TM</sub> = -100 mA			30 -30	mA
łi,	Latching current	$V_{supply} = +12 V^{\dagger}$ $V_{supply} = -12 V^{\dagger}$	(see Note 7)			50 -20		mΑ
dv/dt	Critical rate of rise of off-state voltage	V <sub>DRM</sub> = Rated V <sub>DRM</sub>	l <sub>G</sub> = 0	T <sub>C</sub> = 110°C		±50		V/µs
dv/dt <sub>(c)</sub>	Critical rise of commutation voltage	V <sub>DRM</sub> = Rated V <sub>DRM</sub>	I <sub>TRM</sub> = ±8.4 A	T <sub>C</sub> = 70°C	±5			V/µs

t All voltages are with respect to Main Terminal 1.

NOTES: 6. This parameter must be measured using pulse techniques, to = ≤1 ms, duty cycle ≤2 %. Voltage-sensing contacts separate from the current carrying contacts are tocated within 3.2 mm from the device body.

The tracsarting contacts are tocated within 3.2 min from the Gene body. 7. The tracsarting end by a 15-V (open-circuit amplitude) pulse supplied by a generator with the following characteristics:  $R_G = 100 \Omega$ ,  $t_{p(g)} = 20 \mu s$ ,  $t_r = \le 15 ns$ , f = 1 kHz.

### thermal characteristics

PARAMETER		MIN	TYP	MAX	UNIT
R <sub>ejc</sub>	Junction to case thermal resistance			2.5	°C/W
R <sub>eja</sub>	Junction to free alr thermal resistance			62.5	°C/W

and a state of the st

## PRODUCT INFORMATION